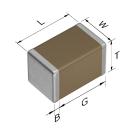
## 积层贴片陶瓷片式电容器

C2012X5R2A683M085AA RoHS Reach Halogen Free Pb Free

交货型号	C2012X5R2A683MT****	
用途	一般等级	
特点	Mid 中耐压(100~630V)	
系列	C2012 [EIA 0805]	
状态	▲ 量产体制(新设计非推荐)	



尺寸		
长度(L)	$2.00 \text{mm} \pm 0.20 \text{mm}$	
宽度(W)	1.25mm ±0.20mm	
厚度(T)	$0.85$ mm $\pm 0.15$ mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.50mm Min.	
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)	
1世存产益4月/回 (FA)	0.90mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)	
JE44/平価/IJ/问(I D)	0.70mm to 0.90mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)	
1年447年21月7日(7-6)	0.90mm to 1.20mm(Reflow Soldering)	

电气特性		
电容	68nF ±20%	
额定电压	100VDC	
温度特性	$X5R(\pm 15\%)$	
耗散因数(Max.)	3%	
绝缘电阻 (Min.)	7352M Ω	

	其他
焊接方法	流体
<b>冲按</b> 力伝	回流
AEC-Q200	NO NO
包装形式	纸编带 (180mm卷筒)
包装个数	4000pcs

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

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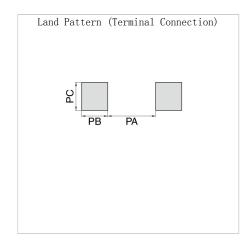
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## Associated Images



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